

1. Description

1.1. Project

Project Name	F103RCTx_TLE5012B
Board Name	custom
Generated with:	STM32CubeMX 6.0.0
Date	08/17/2020

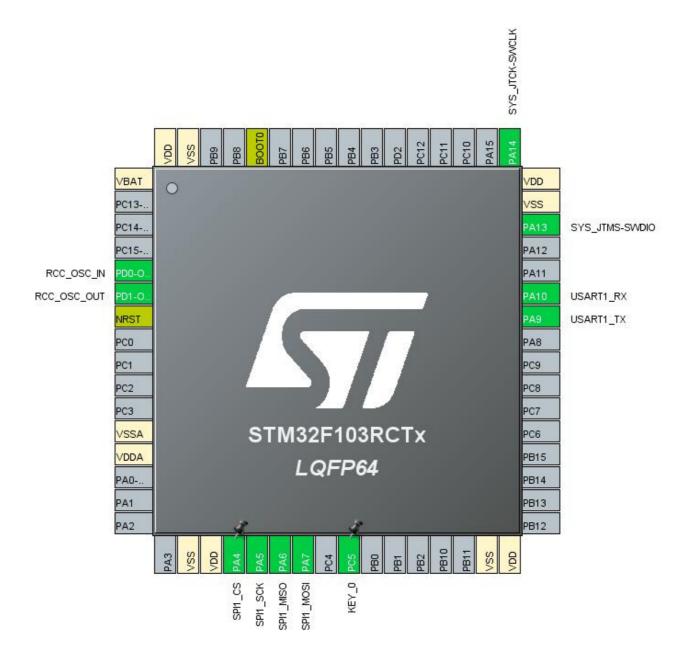
1.2. MCU

MCU Series	STM32F1
MCU Line	STM32F103
MCU name	STM32F103RCTx
MCU Package	LQFP64
MCU Pin number	64

1.3. Core(s) information

Core(s)	Arm Cortex-M3

2. Pinout Configuration

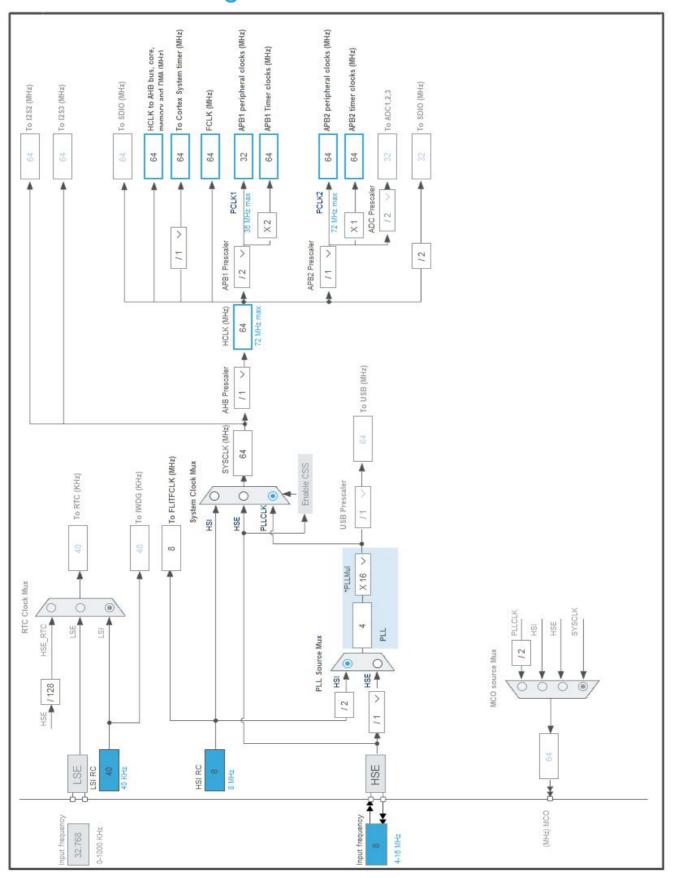


3. Pins Configuration

Pin Number LQFP64	Pin Name (function after reset)	Pin Type	Alternate Function(s)	Label
1	VBAT	Power		
5	PD0-OSC_IN	I/O	RCC_OSC_IN	
6	PD1-OSC_OUT	I/O	RCC_OSC_OUT	
7	NRST	Reset		
12	VSSA	Power		
13	VDDA	Power		
18	VSS	Power		
19	VDD	Power		
20	PA4 *	I/O	GPIO_Output	SPI1_CS
21	PA5	I/O	SPI1_SCK	
22	PA6	I/O	SPI1_MISO	
23	PA7	I/O	SPI1_MOSI	
25	PC5 *	I/O	GPIO_Input	KEY_0
31	VSS	Power		
32	VDD	Power		
42	PA9	I/O	USART1_TX	
43	PA10	I/O	USART1_RX	
46	PA13	I/O	SYS_JTMS-SWDIO	
47	VSS	Power		
48	VDD	Power		
49	PA14	I/O	SYS_JTCK-SWCLK	
60	воото	Boot		
63	VSS	Power		
64	VDD	Power		

^{*} The pin is affected with an I/O function

4. Clock Tree Configuration



5. Software Project

5.1. Project Settings

Name	Value	
Project Name	F103RCTx_TLE5012B	
Project Folder	D:\SrcCode\Keil_Src\F103RCTx_TLE5012B	
Toolchain / IDE	MDK-ARM V5.27	
Firmware Package Name and Version	STM32Cube FW_F1 V1.8.0	
Application Structure	Basic	
Generate Under Root	No	
Do not generate the main()	No	
Minimum Heap Size	0x200	
Minimum Stack Size	0x400	

5.2. Code Generation Settings

Name	Value
STM32Cube MCU packages and embedded software	Copy all used libraries into the project folder
Generate peripheral initialization as a pair of '.c/.h' files	Yes
Backup previously generated files when re-generating	No
Keep User Code when re-generating	Yes
Delete previously generated files when not re-generated	Yes
Set all free pins as analog (to optimize the power consumption)	Yes
Enable Full Assert	No

5.3. Advanced Settings - Generated Function Calls

Rank	Function Name	IP Instance Name
1	MX_GPIO_Init	GPIO
2	SystemClock_Config	RCC
3	MX_SPI1_Init	SPI1
4	MX_USART1_UART_Init	USART1

6. Power Consumption Calculator report

6.1. Microcontroller Selection

Series	STM32F1
Line	STM32F103
мси	STM32F103RCTx
Datasheet	DS5792_Rev12

6.2. Parameter Selection

Temperature	25
Vdd	3.3

6.3. Battery Selection

Battery	Li-SOCL2(A3400)
Capacity	3400.0 mAh
Self Discharge	0.08 %/month
Nominal Voltage	3.6 V
Max Cont Current	100.0 mA
Max Pulse Current	200.0 mA
Cells in series	1
Cells in parallel	1

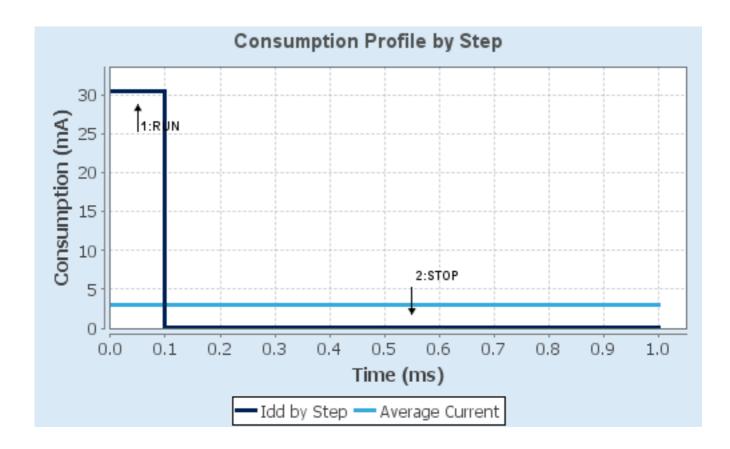
6.4. Sequence

Step	Step1	Step2
Mode	RUN	STOP
Vdd	3.3	3.3
Voltage Source	Battery	Battery
Range	No Scale	No Scale
Fetch Type	FLASH	n/a
CPU Frequency	72 MHz	0 Hz
Clock Configuration	HSE PLL	Regulator LP
Clock Source Frequency	8 MHz	0 Hz
Peripherals		
Additional Cons.	0 mA	0 mA
Average Current	30.5 mA	25 μA
Duration	0.1 ms	0.9 ms
DMIPS	90.0	0.0
Ta Max	100.47	105
Category	In DS Table	In DS Table

6.5. Results

Sequence Time	1 ms	Average Current	3.07 mA
Battery Life	1 month, 15 days,	Average DMIPS	61.0 DMIPS
	15 hours		

6.6. Chart



7. IPs and Middleware Configuration

7.1. **GPIO**

7.2. RCC

High Speed Clock (HSE): Crystal/Ceramic Resonator

7.2.1. Parameter Settings:

System Parameters:

VDD voltage (V) 3.3
Prefetch Buffer Enabled

Flash Latency(WS) 2 WS (3 CPU cycle)

RCC Parameters:

HSI Calibration Value 16
HSE Startup Timout Value (ms) 100
LSE Startup Timout Value (ms) 5000

7.3. SPI1

Mode: Full-Duplex Master

7.3.1. Parameter Settings:

Basic Parameters:

Frame Format Motorola

Data Size 16 Bits *

First Bit MSB First

Clock Parameters:

Prescaler (for Baud Rate)

Baud Rate 8.0 MBits/s *

Clock Polarity (CPOL) Low

Clock Phase (CPHA) 2 Edge *

Advanced Parameters:

CRC Calculation Disabled NSS Signal Type Software

7.4. SYS

Debug: Serial Wire

Timebase Source: SysTick

7.5. USART1

Mode: Asynchronous7.5.1. Parameter Settings:

Basic Parameters:

Baud Rate 115200

Word Length 8 Bits (including Parity)

Parity None Stop Bits 1

Advanced Parameters:

Data Direction Receive and Transmit

Over Sampling 16 Samples

^{*} User modified value

8. System Configuration

8.1. GPIO configuration

IP	Pin	Signal	GPIO mode	GPIO pull/up pull down	Max Speed	User Label
RCC	PD0- OSC_IN	RCC_OSC_IN	n/a	n/a	n/a	
	PD1- OSC_OUT	RCC_OSC_OUT	n/a	n/a	n/a	
SPI1	PA5	SPI1_SCK	Alternate Function Push Pull	n/a	High *	
	PA6	SPI1_MISO	Input mode	No pull-up and no pull-down	n/a	
	PA7	SPI1_MOSI	Alternate Function Push Pull	n/a	High *	
SYS	PA13	SYS_JTMS- SWDIO	n/a	n/a	n/a	
	PA14	SYS_JTCK- SWCLK	n/a	n/a	n/a	
USART1	PA9	USART1_TX	Alternate Function Push Pull	n/a	High *	
	PA10	USART1_RX	Input mode	No pull-up and no pull-down	n/a	
GPIO	PA4	GPIO_Output	Output Push Pull	No pull-up and no pull-down	High *	SPI1_CS
	PC5	GPIO_Input	Input mode	No pull-up and no pull-down	n/a	KEY_0

8.2. DMA configuration

nothing configured in DMA service

8.3. NVIC configuration

8.3.1. NVIC

Interrupt Table	Enable	Preenmption Priority	SubPriority	
Non maskable interrupt	true	0	0	
Hard fault interrupt	true	0	0	
Memory management fault	true	0	0	
Prefetch fault, memory access fault	true	0	0	
Undefined instruction or illegal state	true	0	0	
System service call via SWI instruction	true	0	0	
Debug monitor	true	0	0	
Pendable request for system service	true	0	0	
System tick timer	true	0	0	
PVD interrupt through EXTI line 16	unused			
Flash global interrupt	unused			
RCC global interrupt	unused			
SPI1 global interrupt	unused			
USART1 global interrupt	unused			

8.3.2. NVIC Code generation

Enabled interrupt Table	Select for init	Generate IRQ	Call HAL handler
	sequence ordering	handler	
Non maskable interrupt	true	true	false
Hard fault interrupt	true	true	false
Memory management fault	true	true	false
Prefetch fault, memory access fault	true	true	false
Undefined instruction or illegal state	true	true	false
System service call via SWI instruction	true	true	false
Debug monitor	true	true	false
Pendable request for system service	true	true	false
System tick timer	true	true	true

* User modified value

9. System Views

- 9.1. Category view
- 9.1.1. Current



10. Docs & Resources

Type Link

Datasheet http://www.st.com/resource/en/datasheet/CD00191185.pdf

Reference http://www.st.com/resource/en/reference_manual/CD00171190.pdf

manual

Programming http://www.st.com/resource/en/programming_manual/CD00228163.pdf

manual

Programming http://www.st.com/resource/en/programming_manual/CD00283419.pdf

manual

Errata sheet http://www.st.com/resource/en/errata_sheet/CD00197763.pdf

Application note http://www.st.com/resource/en/application_note/CD00160362.pdf

Application note http://www.st.com/resource/en/application_note/CD00164185.pdf

Application note http://www.st.com/resource/en/application_note/CD00167594.pdf

Application note http://www.st.com/resource/en/application_note/CD00200423.pdf

Application note http://www.st.com/resource/en/application_note/CD00211314.pdf

Application note http://www.st.com/resource/en/application_note/CD00249778.pdf

Application note http://www.st.com/resource/en/application_note/CD00259245.pdf

Application note http://www.st.com/resource/en/application_note/CD00264321.pdf

Application note http://www.st.com/resource/en/application_note/CD00264342.pdf

Application note http://www.st.com/resource/en/application_note/CD00264379.pdf

Application note http://www.st.com/resource/en/application_note/DM00024853.pdf

Application note http://www.st.com/resource/en/application_note/DM00032987.pdf

Application note http://www.st.com/resource/en/application_note/DM00033267.pdf

Application note http://www.st.com/resource/en/application_note/DM00033344.pdf

Application note http://www.st.com/resource/en/application_note/DM00042534.pdf

Application note http://www.st.com/resource/en/application_note/DM00052530.pdf

Application note http://www.st.com/resource/en/application_note/DM00073742.pdf

Application note http://www.st.com/resource/en/application_note/DM00080497.pdf

Application note http://www.st.com/resource/en/application_note/DM00129215.pdf

Application note http://www.st.com/resource/en/application_note/DM00160482.pdf http://www.st.com/resource/en/application_note/DM00156964.pdf Application note Application note http://www.st.com/resource/en/application_note/DM00209695.pdf Application note http://www.st.com/resource/en/application_note/DM00220769.pdf http://www.st.com/resource/en/application_note/DM00257177.pdf Application note Application note http://www.st.com/resource/en/application_note/DM00272912.pdf http://www.st.com/resource/en/application note/DM00236305.pdf Application note Application note http://www.st.com/resource/en/application note/DM00296349.pdf Application note http://www.st.com/resource/en/application note/DM00325582.pdf Application note http://www.st.com/resource/en/application note/DM00327191.pdf Application note http://www.st.com/resource/en/application_note/DM00354244.pdf Application note http://www.st.com/resource/en/application_note/DM00315319.pdf Application note http://www.st.com/resource/en/application_note/DM00380469.pdf Application note http://www.st.com/resource/en/application_note/DM00395696.pdf http://www.st.com/resource/en/application_note/DM00493651.pdf Application note Application note http://www.st.com/resource/en/application_note/DM00536349.pdf